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# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	416
Number of Logic Elements/Cells	4160
Total RAM Bits	53248
Number of I/O	151
Number of Gates	263000
Voltage - Supply	1.71V ~ 1.89V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep20k100eqc208-3

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

- Flexible clock management circuitry with up to four phase-locked loops (PLLs)
  - Built-in low-skew clock tree
  - Up to eight global clock signals
  - ClockLock<sup>®</sup> feature reducing clock delay and skew
  - ClockBoost<sup>®</sup> feature providing clock multiplication and division
  - ClockShift™ programmable clock phase and delay shifting

### Powerful I/O features

- Compliant with peripheral component interconnect Special Interest Group (PCI SIG) PCI Local Bus Specification, Revision 2.2 for 3.3-V operation at 33 or 66 MHz and 32 or 64 bits
- Support for high-speed external memories, including DDR SDRAM and ZBT SRAM (ZBT is a trademark of Integrated Device Technology, Inc.)
- Bidirectional I/O performance ( $t_{CO} + t_{SU}$ ) up to 250 MHz
- LVDS performance up to 840 Mbits per channel
- Direct connection from I/O pins to local interconnect providing fast t<sub>CO</sub> and t<sub>SU</sub> times for complex logic
- MultiVolt I/O interface support to interface with 1.8-V, 2.5-V,
  3.3-V, and 5.0-V devices (see Table 3)
- Programmable clamp to V<sub>CCIO</sub>
- Individual tri-state output enable control for each pin
- Programmable output slew-rate control to reduce switching noise
- Support for advanced I/O standards, including low-voltage differential signaling (LVDS), LVPECL, PCI-X, AGP, CTT, stubseries terminated logic (SSTL-3 and SSTL-2), Gunning transceiver logic plus (GTL+), and high-speed terminated logic (HSTL Class I)
- Pull-up on I/O pins before and during configuration

### Advanced interconnect structure

- Four-level hierarchical FastTrack<sup>®</sup> Interconnect structure providing fast, predictable interconnect delays
- Dedicated carry chain that implements arithmetic functions such as fast adders, counters, and comparators (automatically used by software tools and megafunctions)
- Dedicated cascade chain that implements high-speed, high-fan-in logic functions (automatically used by software tools and megafunctions)
- Interleaved local interconnect allows one LE to drive 29 other LEs through the fast local interconnect

### Advanced packaging options

- Available in a variety of packages with 144 to 1,020 pins (see Tables 4 through 7)
- FineLine BGA® packages maximize board space efficiency

### Advanced software support

 Software design support and automatic place-and-route provided by the Altera® Quartus® II development system for

All APEX 20K devices are reconfigurable and are 100% tested prior to shipment. As a result, test vectors do not have to be generated for fault coverage purposes. Instead, the designer can focus on simulation and design verification. In addition, the designer does not need to manage inventories of different application-specific integrated circuit (ASIC) designs; APEX 20K devices can be configured on the board for the specific functionality required.

APEX 20K devices are configured at system power-up with data stored in an Altera serial configuration device or provided by a system controller. Altera offers in-system programmability (ISP)-capable EPC1, EPC2, and EPC16 configuration devices, which configure APEX 20K devices via a serial data stream. Moreover, APEX 20K devices contain an optimized interface that permits microprocessors to configure APEX 20K devices serially or in parallel, and synchronously or asynchronously. The interface also enables microprocessors to treat APEX 20K devices as memory and configure the device by writing to a virtual memory location, making reconfiguration easy.

After an APEX 20K device has been configured, it can be reconfigured in-circuit by resetting the device and loading new data. Real-time changes can be made during system operation, enabling innovative reconfigurable computing applications.

APEX 20K devices are supported by the Altera Quartus II development system, a single, integrated package that offers HDL and schematic design entry, compilation and logic synthesis, full simulation and worst-case timing analysis, SignalTap logic analysis, and device configuration. The Quartus II software runs on Windows-based PCs, Sun SPARCstations, and HP 9000 Series 700/800 workstations.

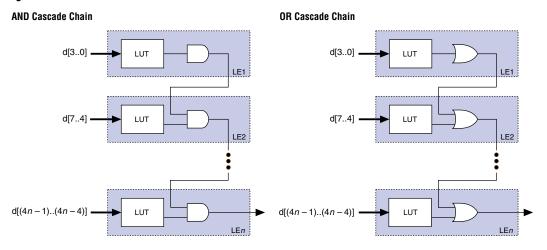
The Quartus II software provides NativeLink interfaces to other industry-standard PC- and UNIX workstation-based EDA tools. For example, designers can invoke the Quartus II software from within third-party design tools. Further, the Quartus II software contains built-in optimized synthesis libraries; synthesis tools can use these libraries to optimize designs for APEX 20K devices. For example, the Synopsys Design Compiler library, supplied with the Quartus II development system, includes DesignWare functions optimized for the APEX 20K architecture.

#### Cascade Chain

With the cascade chain, the APEX 20K architecture can implement functions with a very wide fan-in. Adjacent LUTs can compute portions of a function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a short cascade delay. Cascade chain logic can be created automatically by the Quartus II software Compiler during design processing, or manually by the designer during design entry.

Cascade chains longer than ten LEs are implemented automatically by linking LABs together. For enhanced fitting, a long cascade chain skips alternate LABs in a MegaLAB structure. A cascade chain longer than one LAB skips either from an even-numbered LAB to the next even-numbered LAB, or from an odd-numbered LAB to the next odd-numbered LAB. For example, the last LE of the first LAB in the upper-left MegaLAB structure carries to the first LE of the third LAB in the MegaLAB structure. Figure 7 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in.

Figure 7. APEX 20K Cascade Chain



#### Normal Mode

The normal mode is suitable for general logic applications, combinatorial functions, or wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in are inputs to a four-input LUT. The Quartus II software Compiler automatically selects the carry-in or the DATA3 signal as one of the inputs to the LUT. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. LEs in normal mode support packed registers.

#### Arithmetic Mode

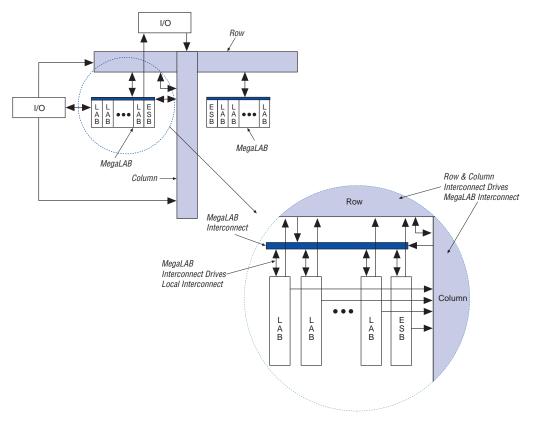
The arithmetic mode is ideal for implementing adders, accumulators, and comparators. An LE in arithmetic mode uses two 3-input LUTs. One LUT computes a three-input function; the other generates a carry output. As shown in Figure 8, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, when implementing an adder, this output is the sum of three signals: DATA1, DATA2, and carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports simultaneous use of the cascade chain. LEs in arithmetic mode can drive out registered and unregistered versions of the LUT output.

The Quartus II software implements parameterized functions that use the arithmetic mode automatically where appropriate; the designer does not need to specify how the carry chain will be used.

#### Counter Mode

The counter mode offers clock enable, counter enable, synchronous up/down control, synchronous clear, and synchronous load options. The counter enable and synchronous up/down control signals are generated from the data inputs of the LAB local interconnect. The synchronous clear and synchronous load options are LAB-wide signals that affect all registers in the LAB. Consequently, if any of the LEs in an LAB use the counter mode, other LEs in that LAB must be used as part of the same counter or be used for a combinatorial function. The Quartus II software automatically places any registers that are not used by the counter into other LABs.

Figure 10. FastTrack Connection to Local Interconnect



From Previous Macrocell Product-Macrocell Term Product-Select Term Logic Matrix Parallel Expander Switch Product-Macrocell Term Product-Select Term Logic Matrix Parallel Expander Switch 32 Signals from To Next

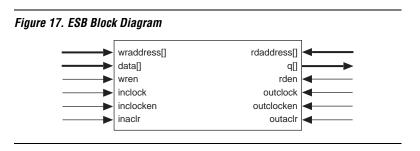
Figure 16. APEX 20K Parallel Expanders

# Embedded System Block

Local Interconnect

The ESB can implement various types of memory blocks, including dual-port RAM, ROM, FIFO, and CAM blocks. The ESB includes input and output registers; the input registers synchronize writes, and the output registers can pipeline designs to improve system performance. The ESB offers a dual-port mode, which supports simultaneous reads and writes at two different clock frequencies. Figure 17 shows the ESB block diagram.

Macrocell



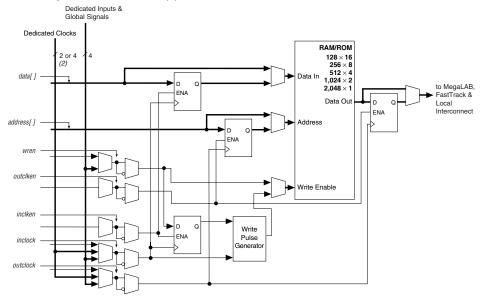


Figure 22. ESB in Single-Port Mode Note (1)

Notes to Figure 22:

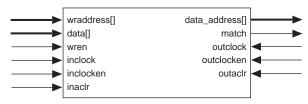
- (1) All registers can be asynchronously cleared by ESB local interconnect signals, global signals, or the chip-wide reset.
- (2) APEX 20KE devices have four dedicated clocks.

### **Content-Addressable Memory**

In APEX 20KE devices, the ESB can implement CAM. CAM can be thought of as the inverse of RAM. When read, RAM outputs the data for a given address. Conversely, CAM outputs an address for a given data word. For example, if the data FA12 is stored in address 14, the CAM outputs 14 when FA12 is driven into it.

CAM is used for high-speed search operations. When searching for data within a RAM block, the search is performed serially. Thus, finding a particular data word can take many cycles. CAM searches all addresses in parallel and outputs the address storing a particular word. When a match is found, a match flag is set high. Figure 23 shows the CAM block diagram.

Figure 23. APEX 20KE CAM Block Diagram



CAM can be used in any application requiring high-speed searches, such as networking, communications, data compression, and cache management.

The APEX 20KE on-chip CAM provides faster system performance than traditional discrete CAM. Integrating CAM and logic into the APEX 20KE device eliminates off-chip and on-chip delays, improving system performance.

When in CAM mode, the ESB implements 32-word, 32-bit CAM. Wider or deeper CAM can be implemented by combining multiple CAMs with some ancillary logic implemented in LEs. The Quartus II software combines ESBs and LEs automatically to create larger CAMs.

CAM supports writing "don't care" bits into words of the memory. The "don't-care" bit can be used as a mask for CAM comparisons; any bit set to "don't-care" has no effect on matches.

The output of the CAM can be encoded or unencoded. When encoded, the ESB outputs an encoded address of the data's location. For instance, if the data is located in address 12, the ESB output is 12. When unencoded, the ESB uses its 16 outputs to show the location of the data over two clock cycles. In this case, if the data is located in address 12, the 12th output line goes high. When using unencoded outputs, two clock cycles are required to read the output because a 16-bit output bus is used to show the status of 32 words.

The encoded output is better suited for designs that ensure duplicate data is not written into the CAM. If duplicate data is written into two locations, the CAM's output will be incorrect. If the CAM may contain duplicate data, the unencoded output is a better solution; CAM with unencoded outputs can distinguish multiple data locations.

CAM can be pre-loaded with data during configuration, or it can be written during system operation. In most cases, two clock cycles are required to write each word into CAM. When "don't-care" bits are used, a third clock cycle is required.



For more information on APEX 20KE devices and CAM, see *Application Note 119 (Implementing High-Speed Search Applications with APEX CAM).* 

### **Driving Signals to the ESB**

ESBs provide flexible options for driving control signals. Different clocks can be used for the ESB inputs and outputs. Registers can be inserted independently on the data input, data output, read address, write address, WE, and RE signals. The global signals and the local interconnect can drive the WE and RE signals. The global signals, dedicated clock pins, and local interconnect can drive the ESB clock signals. Because the LEs drive the local interconnect, the LEs can control the WE and RE signals and the ESB clock, clock enable, and asynchronous clear signals. Figure 24 shows the ESB control signal generation logic.

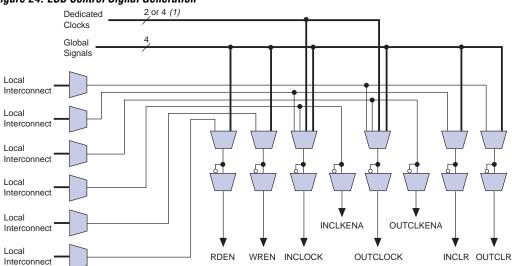


Figure 24. ESB Control Signal Generation

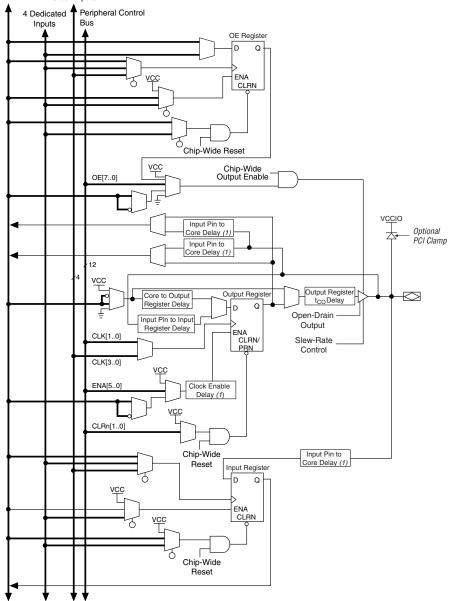
Note to Figure 24:

(1) APEX 20KE devices have four dedicated clocks.

An ESB is fed by the local interconnect, which is driven by adjacent LEs (for high-speed connection to the ESB) or the MegaLAB interconnect. The ESB can drive the local, MegaLAB, or FastTrack Interconnect routing structure to drive LEs and IOEs in the same MegaLAB structure or anywhere in the device.

Figure 26. APEX 20KE Bidirectional I/O Registers Notes (1), (2)

Row, Column, FastRow, 4 Dedicated or Local Interconnect Clock Inputs



Notes to Figure 26:

- (1) This programmable delay has four settings: off and three levels of delay.
- (2) The output enable and input registers are LE registers in the LAB adjacent to the bidirectional pin.

APEX 20KE devices also support the MultiVolt I/O interface feature. The APEX 20KE VCCINT pins must always be connected to a 1.8-V power supply. With a 1.8-V  $V_{CCINT}$  level, input pins are 1.8-V, 2.5-V, and 3.3-V tolerant. The VCCIO pins can be connected to either a 1.8-V, 2.5-V, or 3.3-V power supply, depending on the I/O standard requirements. When the VCCIO pins are connected to a 1.8-V power supply, the output levels are compatible with 1.8-V systems. When VCCIO pins are connected to a 2.5-V power supply, the output levels are compatible with 2.5-V systems. When VCCIO pins are connected to a 3.3-V power supply, the output high is 3.3 V and compatible with 3.3-V or 5.0-V systems. An APEX 20KE device is 5.0-V tolerant with the addition of a resistor.

Table 13 summarizes APEX 20KE MultiVolt I/O support.

Table 13. APEX 20KE MultiVolt I/O Support Note (1)										
V <sub>CCIO</sub> (V)		Input Sig	ınals (V)			Output S	ignals (V)			
	1.8	2.5	3.3	5.0	1.8	2.5	3.3	5.0		
1.8	✓	<b>✓</b>	✓		✓					
2.5	✓	<b>✓</b>	<b>✓</b>			✓				
3.3	✓	<b>✓</b>	<b>\</b>	(2)			<b>√</b> (3)			

### Notes to Table 13:

- The PCI clamping diode must be disabled to drive an input with voltages higher than V<sub>CCIO</sub>, except for the 5.0-V input case.
- (2) An APEX 20KE device can be made 5.0-V tolerant with the addition of an external resistor. You also need a PCI clamp and series resistor.
- (3) When  $V_{CCIO} = 3.3 \text{ V}$ , an APEX 20KE device can drive a 2.5-V device with 3.3-V tolerant inputs.

## ClockLock & ClockBoost Features

APEX 20K devices support the ClockLock and ClockBoost clock management features, which are implemented with PLLs. The ClockLock circuitry uses a synchronizing PLL that reduces the clock delay and skew within a device. This reduction minimizes clock-to-output and setup times while maintaining zero hold times. The ClockBoost circuitry, which provides a clock multiplier, allows the designer to enhance device area efficiency by sharing resources within the device. The ClockBoost circuitry allows the designer to distribute a low-speed clock and multiply that clock on-device. APEX 20K devices include a high-speed clock tree; unlike ASICs, the user does not have to design and optimize the clock tree. The ClockLock and ClockBoost features work in conjunction with the APEX 20K device's high-speed clock to provide significant improvements in system performance and band-width. Devices with an X-suffix on the ordering code include the ClockLock circuit.

The ClockLock and ClockBoost features in APEX 20K devices are enabled through the Quartus II software. External devices are not required to use these features.

### Clock Phase & Delay Adjustment

The APEX 20KE ClockShift feature allows the clock phase and delay to be adjusted. The clock phase can be adjusted by 90° steps. The clock delay can be adjusted to increase or decrease the clock delay by an arbitrary amount, up to one clock period.

### LVDS Support

Two PLLs are designed to support the LVDS interface. When using LVDS, the I/O clock runs at a slower rate than the data transfer rate. Thus, PLLs are used to multiply the I/O clock internally to capture the LVDS data. For example, an I/O clock may run at 105 MHz to support 840 megabits per second (Mbps) LVDS data transfer. In this example, the PLL multiplies the incoming clock by eight to support the high-speed data transfer. You can use PLLs in EP20K400E and larger devices for high-speed LVDS interfacing.

### Lock Signals

The APEX 20KE ClockLock circuitry supports individual LOCK signals. The LOCK signal drives high when the ClockLock circuit has locked onto the input clock. The LOCK signals are optional for each ClockLock circuit; when not used, they are I/O pins.

### ClockLock & ClockBoost Timing Parameters

For the ClockLock and ClockBoost circuitry to function properly, the incoming clock must meet certain requirements. If these specifications are not met, the circuitry may not lock onto the incoming clock, which generates an erroneous clock within the device. The clock generated by the ClockLock and ClockBoost circuitry must also meet certain specifications. If the incoming clock meets these requirements during configuration, the APEX 20K ClockLock and ClockBoost circuitry will lock onto the clock during configuration. The circuit will be ready for use immediately after configuration. In APEX 20KE devices, the clock input standard is programmable, so the PLL cannot respond to the clock until the device is configured. The PLL locks onto the input clock as soon as configuration is complete. Figure 30 shows the incoming and generated clock specifications.



For more information on ClockLock and ClockBoost circuitry, see *Application Note 115: Using the ClockLock and ClockBoost PLL Features in APEX Devices*.

Table 31. APEX 2	Table 31. APEX 20K f <sub>MAX</sub> Timing Parameters (Part 2 of 2)						
Symbol	Parameter						
t <sub>ESBDATACO2</sub>	ESB clock-to-output delay without output registers						
t <sub>ESBDD</sub>	ESB data-in to data-out delay for RAM mode						
t <sub>PD</sub>	ESB macrocell input to non-registered output						
t <sub>PTERMSU</sub>	ESB macrocell register setup time before clock						
t <sub>PTERMCO</sub>	ESB macrocell register clock-to-output delay						
t <sub>F1-4</sub>	Fanout delay using local interconnect						
t <sub>F5-20</sub>	Fanout delay using MegaLab Interconnect						
t <sub>F20+</sub>	Fanout delay using FastTrack Interconnect						
t <sub>CH</sub>	Minimum clock high time from clock pin						
t <sub>CL</sub>	Minimum clock low time from clock pin						
t <sub>CLRP</sub>	LE clear pulse width						
t <sub>PREP</sub>	LE preset pulse width						
t <sub>ESBCH</sub>	Clock high time						
t <sub>ESBCL</sub>	Clock low time						
t <sub>ESBWP</sub>	Write pulse width						
t <sub>ESBRP</sub>	Read pulse width						

Tables 32 and 33 describe APEX 20K external timing parameters.

Table 32. APEX 20K External Timing Parameters Note (1)						
Symbol	Clock Parameter					
t <sub>INSU</sub>	Setup time with global clock at IOE register					
t <sub>INH</sub>	Hold time with global clock at IOE register					
t <sub>OUTCO</sub>	Clock-to-output delay with global clock at IOE register					

Table 33. APEX 20K External Bidirectional Timing Parameters Note (1)								
Symbol	Parameter	Conditions						
t <sub>INSUBIDIR</sub>	Setup time for bidirectional pins with global clock at same-row or same-column LE register							
t <sub>INHBIDIR</sub>	Hold time for bidirectional pins with global clock at same-row or same-column LE register							
<sup>t</sup> OUTCOBIDIR	Clock-to-output delay for bidirectional pins with global clock at IOE register	C1 = 10 pF						
t <sub>XZBIDIR</sub>	Synchronous IOE output buffer disable delay	C1 = 10 pF						
t <sub>ZXBIDIR</sub>	Synchronous IOE output buffer enable delay, slow slew rate = off	C1 = 10 pF						

Table 36. APEX 20KE Routing Timing Microparameters Note (1)						
Symbol	Parameter					
t <sub>F1-4</sub>	Fanout delay using Local Interconnect					
t <sub>F5-20</sub>	Fanout delay estimate using MegaLab Interconnect					
t <sub>F20+</sub>	Fanout delay estimate using FastTrack Interconnect					

### Note to Table 36:

(1) These parameters are worst-case values for typical applications. Post-compilation timing simulation and timing analysis are required to determine actual worst-case performance.

Table 37. APE	Table 37. APEX 20KE Functional Timing Microparameters						
Symbol	Parameter						
TCH	Minimum clock high time from clock pin						
TCL	Minimum clock low time from clock pin						
TCLRP	LE clear Pulse Width						
TPREP	LE preset pulse width						
TESBCH	Clock high time for ESB						
TESBCL	Clock low time for ESB						
TESBWP	Write pulse width						
TESBRP	Read pulse width						

Tables 38 and 39 describe the APEX 20KE external timing parameters.

Table 38. APEX 20KE External Timing Parameters Note (1)						
Symbol	Clock Parameter	Conditions				
t <sub>INSU</sub>	Setup time with global clock at IOE input register					
t <sub>INH</sub>	Hold time with global clock at IOE input register					
t <sub>OUTCO</sub>	Clock-to-output delay with global clock at IOE output register	C1 = 10 pF				
t <sub>INSUPLL</sub>	Setup time with PLL clock at IOE input register					
t <sub>INHPLL</sub>	Hold time with PLL clock at IOE input register					
t <sub>OUTCOPLL</sub>	Clock-to-output delay with PLL clock at IOE output register	C1 = 10 pF				

Symbol	-	1	-2		-	3	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>INSUBIDIR</sub>	2.77		2.91		3.11		ns
t <sub>INHBIDIR</sub>	0.00		0.00		0.00		ns
toutcobidir	2.00	4.84	2.00	5.31	2.00	5.81	ns
t <sub>XZBIDIR</sub>		6.47		7.44		8.65	ns
t <sub>ZXBIDIR</sub>		6.47		7.44		8.65	ns
t <sub>INSUBIDIRPLL</sub>	3.44		3.24		-		ns
t <sub>INHBIDIRPLL</sub>	0.00		0.00		-		ns
t <sub>OUTCOBIDIRPLL</sub>	0.50	3.37	0.50	3.69	-	-	ns
txzbidirpll		5.00		5.82		-	ns
t <sub>ZXBIDIRPLL</sub>		5.00		5.82		-	ns

Tables 61 through 66 describe  $f_{MAX}$  LE Timing Microparameters,  $f_{MAX}$  ESB Timing Microparameters,  $f_{MAX}$  Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K100E APEX 20KE devices.

Table 61. EP2	OK100E f <sub>MAX</sub>	LE Timing Mic	croparameters	3			
Symbol	-	1	-	2	-1	3	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>SU</sub>	0.25		0.25		0.25		ns
t <sub>H</sub>	0.25		0.25		0.25		ns
t <sub>CO</sub>		0.28		0.28		0.34	ns
t <sub>LUT</sub>		0.80		0.95		1.13	ns

Tables 67 through 72 describe  $f_{MAX}$  LE Timing Microparameters,  $f_{MAX}$  ESB Timing Microparameters,  $f_{MAX}$  Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K160E APEX 20KE devices.

Table 67. EP20K160E f <sub>MAX</sub> LE Timing Microparameters										
Symbol	_	1		-2	-	3	Unit			
	Min	Max	Min	Max	Min	Max				
t <sub>SU</sub>	0.22		0.24		0.26		ns			
t <sub>H</sub>	0.22		0.24		0.26		ns			
t <sub>CO</sub>		0.25		0.31		0.35	ns			
t <sub>LUT</sub>		0.69		0.88		1.12	ns			

Tables 85 through 90 describe  $f_{MAX}$  LE Timing Microparameters,  $f_{MAX}$  ESB Timing Microparameters,  $f_{MAX}$  Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K400E APEX 20KE devices.

Table 85. EP2	OK400E f <sub>MAX</sub>	LE Timing Mic	roparameter	s			
Symbol	-1 Spee	d Grade	-2 Spec	ed Grade	-3 Spee	d Grade	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>SU</sub>	0.23		0.23		0.23		ns
t <sub>H</sub>	0.23		0.23		0.23		ns
t <sub>CO</sub>		0.25		0.29		0.32	ns
t <sub>LUT</sub>		0.70		0.83		1.01	ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>INSUBIDIR</sub>	3.22		3.33		3.51		ns
t <sub>INHBIDIR</sub>	0.00		0.00		0.00		ns
t <sub>OUTCOBIDIR</sub>	2.00	5.75	2.00	6.33	2.00	6.90	ns
t <sub>XZBIDIR</sub>		6.31		7.09		7.76	ns
tzxbidir		6.31		7.09		7.76	ns
t <sub>INSUBIDIRPL</sub> L	3.25		3.26				ns
t <sub>INHBIDIRPLL</sub>	0.00		0.00				ns
t <sub>OUTCOBIDIRPLL</sub>	0.50	2.25	0.50	2.99			ns
txzbidirpll		2.81		3.80			ns
tzxbidirpll		2.81		3.80			ns

Tables 103 through 108 describe  $f_{MAX}$  LE Timing Microparameters,  $f_{MAX}$  ESB Timing Microparameters,  $f_{MAX}$  Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K1500E APEX 20KE devices.

Table 103. EP20K1500E f <sub>MAX</sub> LE Timing Microparameters											
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit				
	Min	Max	Min	Max	Min	Max	7				
t <sub>SU</sub>	0.25		0.25		0.25		ns				
t <sub>H</sub>	0.25		0.25		0.25		ns				
t <sub>CO</sub>		0.28		0.32		0.33	ns				
t <sub>LUT</sub>		0.80		0.95		1.13	ns				

### Version 4.1

APEX 20K Programmable Logic Device Family Data Sheet version 4.1 contains the following changes:

- t<sub>ESBWEH</sub> added to Figure 37 and Tables 35, 50, 56, 62, 68, 74, 86, 92, 97, and 104.
- Updated EP20K300E device internal and external timing numbers in Tables 79 through 84.



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